

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Jiang et al. Art Unit: 1765
Serial No.: 09/966,605 Examiner: Vinh, Lan
Filing Date: 09/28/2001 Docket No.: TI-31462
Customer No.: 23494 Conf. No.: 4769
Title: IN-SITU PLASMA ASH/TREATMENT AFTER VIA ETCH OF LOW-K
FILMS FOR POISON-FREE DUAL DAMASCENE TRENCH PATTERNING

REQUEST FOR EXTENSION OF TIME

Commissioner of Patents
PO Box 1450
Alexandria, VA 22313-1450

Dear Sir:

CERTIFICATION OF FACSIMILE TRANSMISSION

I hereby certify that the following papers are being transmitted by
facsimile to the U.S. Patent and Trademark Office at 703-872-9306 on
the date shown below:

Jacqueline J. Garner, Reg. No. 36,144

April 19, 2004
Date

Pursuant to 37 CFR 1.136(a), Applicant(s) respectfully petitions the Commissioner
for an extension of the shortened statutory period for response in the above-identified
Application.

The fee for this extension is indicated below:

- ☐ One Month (\$110)
☒ Two Months (\$420)
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☐ Four Months (\$1,480)

Please charge the fee to deposit account no. 20-0668. Any further necessary
extension of time is hereby requested. Charge any and all fees to deposit account no. 20-
0668. An original and two copies of this sheet are enclosed.

Texas Instruments Incorporated
PO Box 655474, M/S 3999
Dallas, TX 75265
(214) 532-9348
Fax: (972) 917-4418

Respectfully Submitted,

Jacqueline J. Garner
Reg. No. 36,144

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OFFICIAL**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

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Jacqueline J. Garner, Reg. No. 36,144April 19, 2004
Date**FACSIMILE COVER SHEET**

<input checked="" type="checkbox"/> FACSIMILE COVER SHEET	<input checked="" type="checkbox"/> AMENDMENT (9 Pages)
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<input type="checkbox"/> CONTINUATION APP'N (# Pages)	<input checked="" type="checkbox"/> RCE transmittal (1 page)
<input type="checkbox"/> DIVISIONAL APP'N	
NAME OF INVENTOR(S): Jiang et al	
TITLE OF INVENTION: In-Situ Plasma/Ash/Treatment . . .	
TI FILE NO.: TI-31462	DEPOSIT ACCT. NO.: 20-0668
FAXED: 4/19/2004 DUE: 2/18/2004 ATTY/SEC'Y: JJC	
RECEIPT DATE & SERIAL NO.: Serial No.: 09/966,605 Filing Date: 09/28/2001	

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